

Subst. Form PTO-1449

APPLICANT'S INFORMATION
DISCLOSURE STATEMENT

Atty. Docket No.: FIS920010127US1 (IFI-10-5579)

Serial No.:

To be assigned

Applicant: Casey, et al.

Filing Date: Herewith

Group:



U.S. PATENT DOCUMENTS

Initial*		Document No.	Date	Name	Class	Subcl.	Filing Date
JTA	AA	5,716,663	Feb. 10, 1998	Capote, et al.	427	96	June 7, 1995
	AB	5,637,834	June 10, 1997	La Bate Jr., et al.	174	264	Feb. 3, 1995
	AC	5,558,928	Sep. 24, 1996	DiStefano, et al.	428	209	July 21, 1994
	AD	5,480,503	Jan 2, 1996	Casey, et al.	156	89	Dec. 30, 1993
JTA	AE	5,006,923	Apr 9, 1991	Warren	357	80	Sep 14, 1989
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Class	Subcl.	Translation?
JTA	AL	JP1215096	Aug. 29, 1989	Japan	H05K3	46	Abstract
	AM						
	AN						

OTHER DOCUMENTS

JTA	AO	IBM Technical Disclosure Bulletin, Vol. 38, No. 08, August 1995, entitled "Manufacture of Print Circuit Boards using Suspended Conductive Material Bonded by Heat", pages 105-106					
	AP						
	AQ						
	AR						
	AS						
	AT						

Examiner:

Date Considered:

5/29/03

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if in conformance and not considered.
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